

TYN30W-800T

Rev.01 - 11 November 2022

Product data sheet

1. General description

Planar passivated Silicon Controlled Rectifier (SCR) in a TO247 plastic package intended for use in applications requiring very high inrush current capability, high thermal cycling performance and high junction temperature capability ($T_{i(max)} = 150$ °C).

2. Features and benefits

- High junction operating temperature capability (T_{j(max)} = 150 °C)
- · Very high current surge capability
- · Planar passivated for voltage ruggedness and reliability
- High thermal cycling performance
- High voltage capability

3. Applications

- Line rectifying 50/60 Hz
- Softstart AC motor control
- DC Motor control
- Power converter
- AC power control
- Lighting and temperature control
- Uninterruptible Power Supply (UPS)
 Solid State Bolov (SSB)
- Solid State Relay (SSR)Traction battery charging

4. Quick reference data

Symbol	Parameter	Conditions	Notes	Values	Unit
V_{DRM}	repetitive peak off-state voltage			800	V
I _{T(RMS)}	RMS on-state current	half sine wave; T _{mb} ≤ 137 °C; <u>Fig. 1; Fig. 2</u> ; <u>Fig. 3</u>		30	A
I _{TSM}	non-repetitive peak on- state current	half sine wave; T _{j(init)} = 25 °C; t _p = 10 ms; <u>Fig 4</u> ; <u>Fig 5</u>		400	A
		half sine wave; $T_{j(init)}$ = 25 °C; t_p = 8.3 ms		440	А
Tj	junction temperature			150	°C

Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static ch	aracteristics						
I _{GT}	gate trigger current	$V_{\rm D}$ = 12 V; I _T = 0.1 A; T _j = 25 °C; <u>Fig. 7</u>		6	-	15	mA
I _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 9</u>		-	-	60	mA
V _T	on-state voltage	I _T = 30 A; T _j = 25 °C; <u>Fig. 10</u>		-	1.10	1.30	V
		I _T = 60 A; T _j = 25 °C; <u>Fig. 10</u>		-	1.30	1.50	V
Dynamic	characteristics						
$dV_{\rm D}/dt$	rate of rise of off-state voltage	V_{DM} = 402 V; T _j = 150 °C; exponential waveform; gate open circuit		1000	-	-	V/µs

5. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	К	cathode		
2	A	anode		A H K G
3	G	gate		sym037
mb	A	mounting base; connected to anode		

6. Ordering information

Table 3. Ordering information							
Type number	Package Name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date	
TYN30W-800T	TO247	TYN30W-800TQ	Tube	30	TO247E	18-Jun-2021	

7. Marking

Table 4. Marking codes

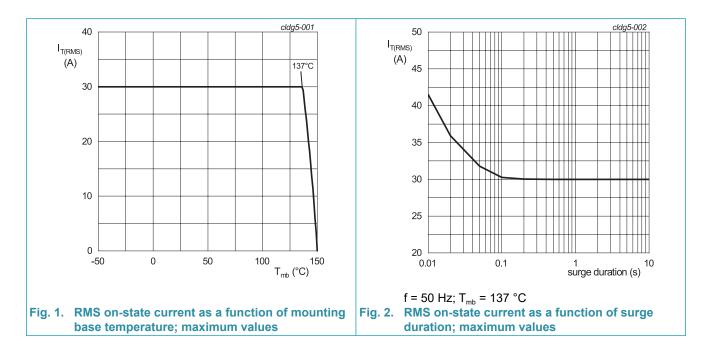
Type number	Marking codes
TYN30W-800T	TYN30W 800T

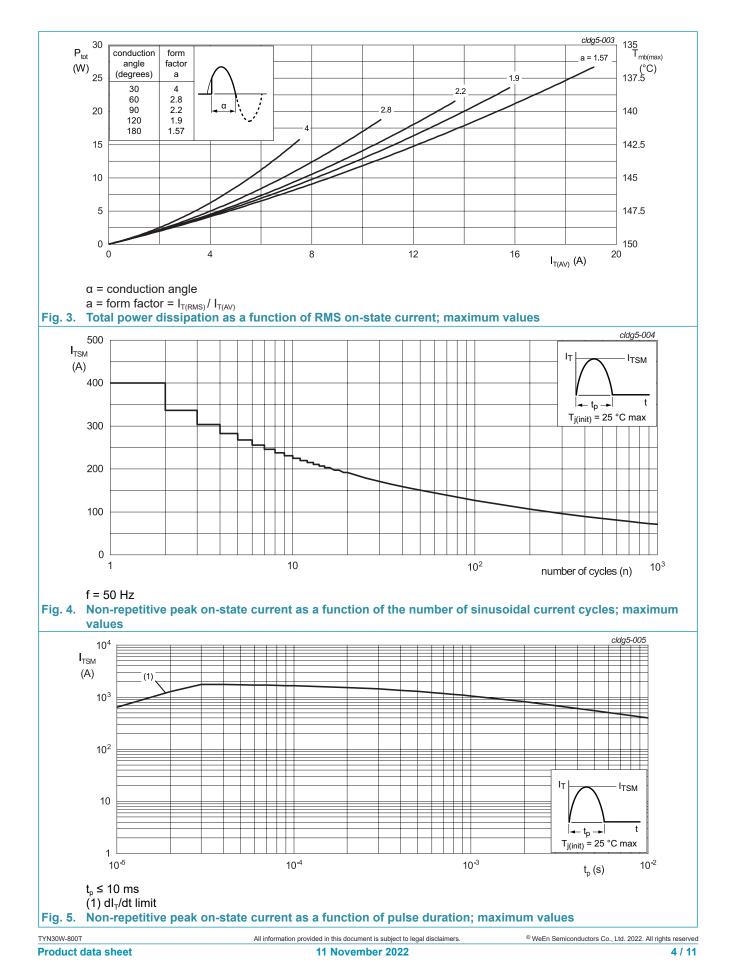
8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

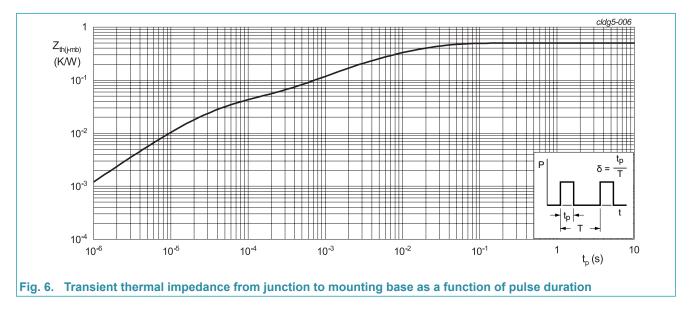
Symbol	Parameter	Conditions	Notes	Values	Unit
V_{DRM}	repetitive peak off-state voltage			800	V
V_{RRM}	repetitive peak reverse voltage			800	V
I _{T(AV)}	average on-state current	half sine wave; T _{mb} ≤ 137 °C;		19	А
I _{T(RMS)}	RMS on-state current	half sine wave; T _{mb} ≤ 137 °C; <u>Fig. 1; Fig. 2; Fig. 3</u>		30	A
I _{TSM}	non-repetitive peak on- state current	half sine wave; $T_{j(init)}$ = 25 °C; t_p = 10 ms; Fig 4; Fig 5		400	A
		half sine wave; $T_{j(init)}$ = 25 °C; t_p = 8.3 ms		440	А
l²t	l ² t for fusing	t _p = 10 ms; sine-wave pulse		800	A ² s
dl⊤/dt	rate of rise of on-state current	I _G = 30 mA		200	A/µs
I _{GM}	peak gate current			5	А
V_{GM}	peak gate voltage			5	V
V _{RGM}	peak reverse gate voltage			7	V
P _{GM}	peak gate power			20	W
P _{G(AV)}	average gate power	over any 20 ms period		0.5	W
T _{stg}	storage temperature			-40 to 150	°C
Ti	junction temperature			150	°C





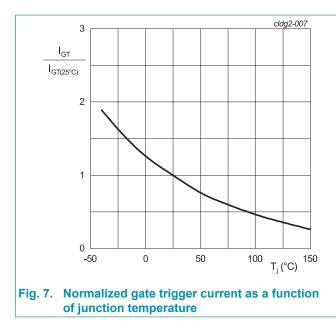
9. Thermal characteristics

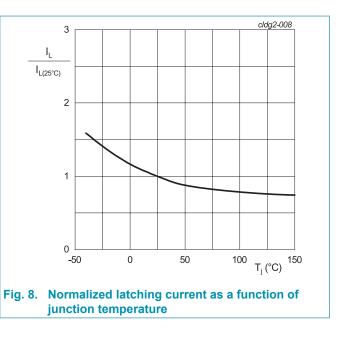
Table 6. Th	able 6. Thermal characteristics							
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit	
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	Fig 6		-	-	0.5	K/W	
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air		-	55	-	K/W	

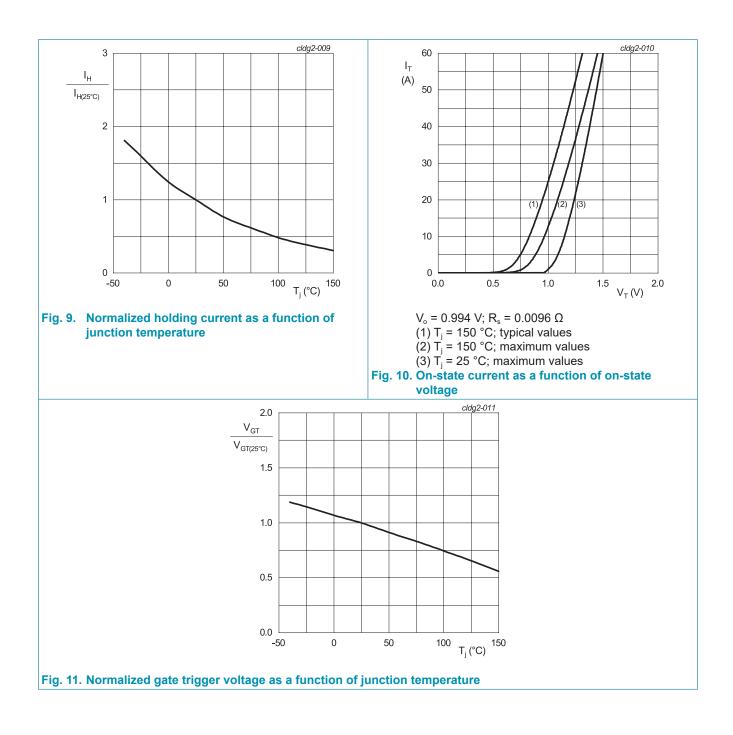


10. Characteristics

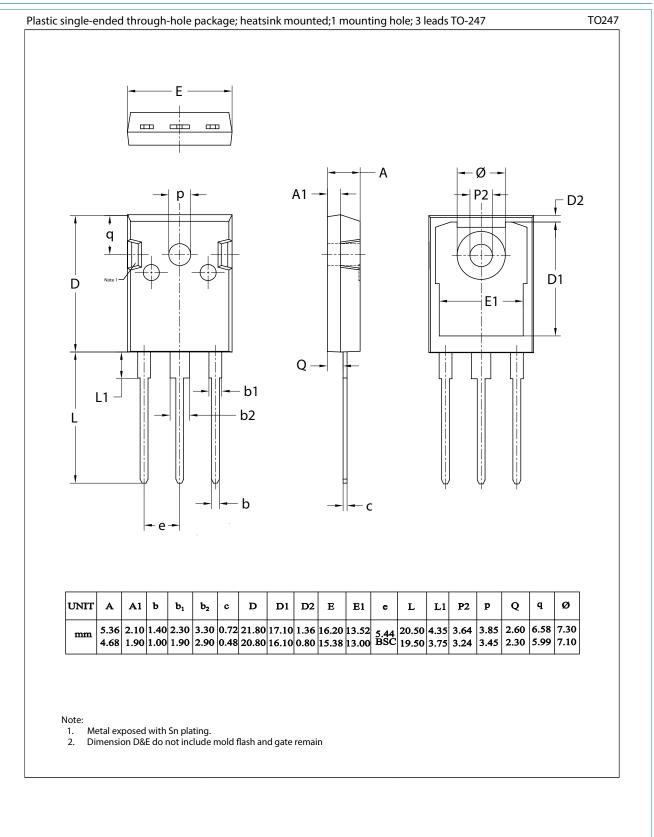
	naracteristics						
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static cha	racteristics						
I _{GT}	gate trigger current	$V_{\rm D}$ = 12 V; I _T = 0.1 A; T _j = 25 °C; <u>Fig. 7</u>		6	-	15	mA
I _L	latching current	$V_{\rm D}$ = 12 V; I _G = 0.1 A; T _j = 25 °C; <u>Fig. 8</u>		-	-	80	mA
I _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 9</u>		-	-	60	mA
V _T	on-state voltage	I _T = 30 A; T _j = 25 °C; <u>Fig. 10</u>		-	1.10	1.30	V
		I _T = 60 A; T _j = 25 °C; <u>Fig. 10</u>		-	1.30	1.50	V
V _{GT}	gate trigger voltage	V _D = 12 V; I _T = 0.1 A;T _j = 25 °C; <u>Fig. 11</u>		-	0.6	1	V
		V _D = 400 V; I _T = 0.1 A;T _j = 150 °C		0.25	0.4	-	V
I _D	off-state current	V _D = 800 V; T _j = 25 °C		-	-	10	μA
		V _D = 800 V; T _j = 150 °C		-	-	1	mA
I _R	reverse current	V _R = 800 V; T _j = 25 °C		-	-	10	μA
		V _R = 800 V; T _j = 150 °C		-	-	1	mA
Dynamic	characteristics	1					
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 402 V; T _j = 150 °C; exponential waveform; gate open circuit		1000	-	-	V/µs
		V_{DM} = 536 V; T _j = 150 °C; (V_{DM} = 67% of V_{DRM}); exponential waveform; gate open circuit		500	-	-	V/µs
t _{gt}	gate-controlled turn-on time	$I_{TM} = 30 \text{ A}; V_D = 800 \text{ V}; I_G = 100 \text{ mA};$ $dI_G/dt = 5 \text{ A}/\mu\text{s}; T_j = 25 \text{ °C}$		-	2	-	μs
t _q	commutated turn-off time	$V_{DM} = 536 \text{ V}; \text{ T}_{j} = 150 \text{ °C}; \text{ I}_{TM} = 30 \text{ A};$ $V_{R} = 25 \text{ V}; \text{ dI}_{T}/\text{dt} = 30 \text{ A}/\mu\text{s}; \text{ dV}_{D}/\text{dt} = 50 \text{ V}/\mu\text{s}$		-	70	-	μs







11. Package outline



12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
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